

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RM} V _{RWM} V _R	35	V
RMS Reverse Voltage	V _{R(RMS)}	25	V
Average Rectified Output Current (See also figure 5)	lo	8	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	120	А

Thermal Characteristics

Characteristic	Symbol	Тур	Max	Unit
Thermal Resistance Junction to Soldering Point	$R_{ heta JS}$	_	3.0	°C/W
Thermal Resistance Junction to Ambient Air (Note 5) T _A = +25°C	$R_{ hetaJA}$	100	_	°C/W
Thermal Resistance Junction to Ambient Air (Note 6) $T_A = +25$ °C	$R_{ hetaJA}$	65		°C/W
Thermal Resistance Junction to Ambient Air (Note 7) $T_A = +25$ °C	$R_{ hetaJA}$	45	_	°C/W
Operating Temperature Range	T_J	-65 to	+125	°C
Storage Temperature Range	T _{STG}	-65 to	+150	°C

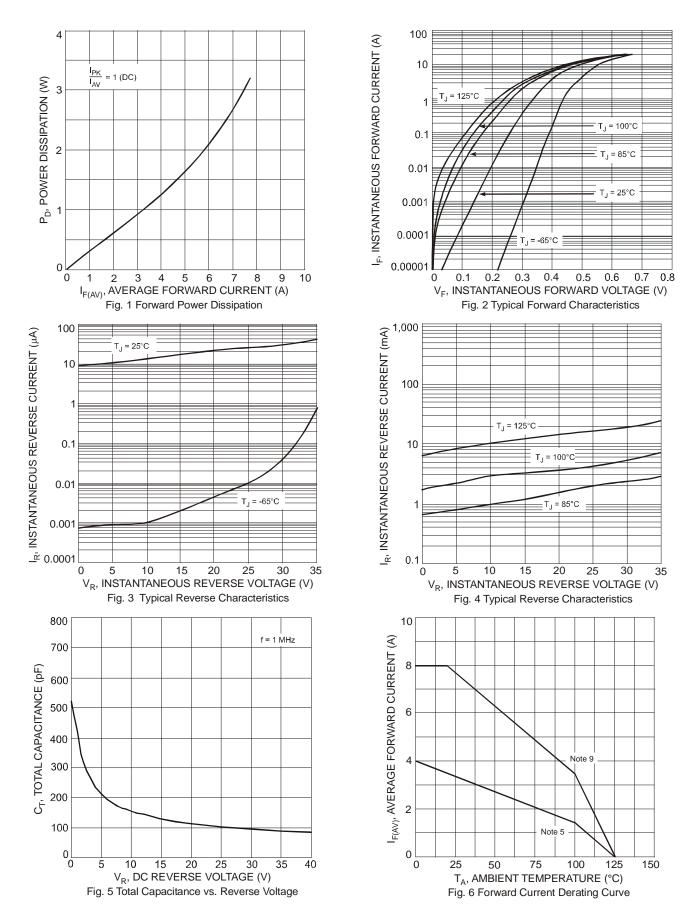
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 8)	$V_{(BR)R}$	35		_	V	$I_R = 1mA$
Forward Voltage	V _F	_	0.46	0.51 0.41		I _F = 8A, T _S = +25°C I _F = 8A, T _S = +125°C
Reverse Leakage Current (Note 8)	I _R		0.05 7	1.4 35	l ma	$T_S = +25$ °C, $V_R = 35$ V $T_S = +100$ °C, $V_R = 35$ V

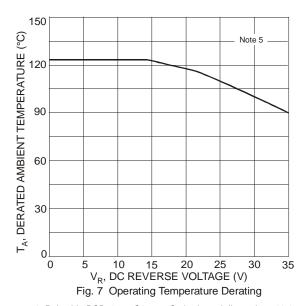
Notes:

- 5. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com
- Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
 Polymide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.
- 8. Short duration pulse test used to minimize self-heating effect.





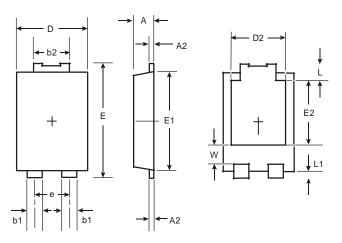




Notes: 9. Polymide PCB, 2 oz. Copper. Cathode pad dimensions 18.8mm x 14.4mm. Anode pad dimensions 5.6mm x 3.0mm.

Package Outline Dimensions

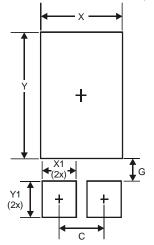
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



POWERDI5			
Dim	Min	Max	
Α	1.05	1.15	
A2	0.33	0.43	
b1	0.80	0.99	
b2	1.70	1.88	
D	3.90	4.05	
D2	3.054 Typ		
Е	6.40	6.60	
е	1.84 Typ		
E1	5.30	5.45	
E2	3.549 Typ		
L	0.75	0.95	
L1	0.50	0.65	
W	1.10	1.41	
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	1.840
G	0.852
Х	3.360
X1	1.390
Y	4.860
Y1	1.400



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